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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	40MHz
Connectivity	I <sup>2</sup> C, IrDA, LINbus, PMP, SPI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, I <sup>2</sup> S, POR, PWM, WDT
Number of I/O	33
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 3.6V
Data Converters	A/D 13x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic32mx220f032dt-v-pt">https://www.e-xfl.com/product-detail/microchip-technology/pic32mx220f032dt-v-pt</a>

# PIC32MX1XX/2XX 28/36/44-PIN FAMILY

TABLE 11: PIN NAMES FOR 44-PIN GENERAL PURPOSE DEVICES

<b>44-PIN TQFP (TOP VIEW)<sup>(1,2,3,5)</sup></b>  <b>PIC32MX110F016D</b> <b>PIC32MX120F032D</b> <b>PIC32MX130F064D</b> <b>PIC32MX130F256D</b> <b>PIC32MX150F128D</b> <b>PIC32MX170F256D</b>				44  1			
Pin #	Full Pin Name	Pin #	Full Pin Name	Pin #	Full Pin Name	Pin #	Full Pin Name
1	RPB9/SDA1/CTED4/PMD3/RB9	23	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/RB2	23	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/RB2		
2	RPC6/PMA1/RC6	24	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/RB3	24	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/RB3		
3	RPC7/PMA0/RC7	25	AN6/RPC0/RC0	25	AN6/RPC0/RC0		
4	RPC8/PMA5/RC8	26	AN7/RPC1/RC1	26	AN7/RPC1/RC1		
5	RPC9/CTED7/PMA6/RC9	27	AN8/RPC2/PMA2/RC2	27	AN8/RPC2/PMA2/RC2		
6	VSS	28	VDD	28	VDD		
7	VCAP	29	VSS	29	VSS		
8	PGED2/RPB10/CTED11/PMD2/RB10	30	OSC1/CLKI/RPA2/RA2	30	OSC1/CLKI/RPA2/RA2		
9	PGEC2/RPB11/PMD1/RB11	31	OSC2/CLKO/RPA3/RA3	31	OSC2/CLKO/RPA3/RA3		
10	AN12/PMD0/RB12	32	TDO/RPA8/PMA8/RA8	32	TDO/RPA8/PMA8/RA8		
11	AN11/RPB13/CTPLS/PMRD/RB13	33	SOSCI/RPB4/RB4	33	SOSCI/RPB4/RB4		
12	PGED4 <sup>(4)</sup> /TMS/PMA10/RA10	34	SOSCO/RPA4/T1CK/CTED9/RA4	34	SOSCO/RPA4/T1CK/CTED9/RA4		
13	PGEC4 <sup>(4)</sup> /TCK/CTED8/PMA7/RA7	35	TDI/RPA9/PMA9/RA9	35	TDI/RPA9/PMA9/RA9		
14	CVREFOUT/AN10/C3INB/RPB14/SCK1/CTED5/PMWR/RB14	36	RPC3/RC3	36	RPC3/RC3		
15	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15	37	RPC4/PMA4/RC4	37	RPC4/PMA4/RC4		
16	AVSS	38	RPC5/PMA3/RC5	38	RPC5/PMA3/RC5		
17	AVDD	39	VSS	39	VSS		
18	MCLR	40	VDD	40	VDD		
19	VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/RA0	41	PGED3/RPB5/PMD7/RB5	41	PGED3/RPB5/PMD7/RB5		
20	VREF-/CVREF-/AN1/RPA1/CTED2/RA1	42	PGEC3/RPB6/PMD6/RB6	42	PGEC3/RPB6/PMD6/RB6		
21	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/RB0	43	RPB7/CTED3/PMD5/INT0/RB7	43	RPB7/CTED3/PMD5/INT0/RB7		
22	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/RB1	44	RPB8/SCL1/CTED10/PMD4/RB8	44	RPB8/SCL1/CTED10/PMD4/RB8		

- Note**
- 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and **Section 11.3 “Peripheral Pin Select”** for restrictions.
  - 2: Every I/O port pin (RAX-RCx) can be used as a change notification pin (CNAX-CNCx). See **Section 11.0 “I/O Ports”** for more information.
  - 3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to VSS externally.
  - 4: This pin function is not available on PIC32MX110F016D and PIC32MX120F032D devices.
  - 5: Shaded pins are 5V tolerant.

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**REGISTER 4-7: BMXPFMSZ: PROGRAM FLASH (PFM) SIZE REGISTER**

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R	R	R	R	R	R	R	R
BMXPFMSZ<31:24>								
23:16	R	R	R	R	R	R	R	R
BMXPFMSZ<23:16>								
15:8	R	R	R	R	R	R	R	R
BMXPFMSZ<15:8>								
7:0	R	R	R	R	R	R	R	R
BMXPFMSZ<7:0>								

**Legend:**

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 31-0 **BMXPFMSZ<31:0>**: Program Flash Memory (PFM) Size bits

Static value that indicates the size of the PFM in bytes:

0x00004000 = Device has 16 KB Flash

0x00008000 = Device has 32 KB Flash

0x00010000 = Device has 64 KB Flash

0x00020000 = Device has 128 KB Flash

0x00040000 = Device has 256 KB Flash

**REGISTER 4-8: BMXBOOTSZ: BOOT FLASH (IFM) SIZE REGISTER**

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R	R	R	R	R	R	R	R
BMXBOOTSZ<31:24>								
23:16	R	R	R	R	R	R	R	R
BMXBOOTSZ<23:16>								
15:8	R	R	R	R	R	R	R	R
BMXBOOTSZ<15:8>								
7:0	R	R	R	R	R	R	R	R
BMXBOOTSZ<7:0>								

**Legend:**

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 31-0 **BMXBOOTSZ<31:0>**: Boot Flash Memory (BFM) Size bits

Static value that indicates the size of the Boot PFM in bytes:

0x00000C00 = Device has 3 KB boot Flash

## 9.1 DMA Control Registers

**TABLE 9-1: DMA GLOBAL REGISTER MAP**

Virtual Address (BF88_#)	Register Name <sup>(1)</sup>	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
3000	DMACON	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000	
		15:0	ON	—	—	SUSPEND	DMABUSY	—	—	—	—	—	—	—	—	—	—	0000	
3010	DMASTAT	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000	
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	RDWR	DMACH<2:0> <sup>(2)</sup>		0000	
3020	DMAADDR	31:16	DMAADDR<31:0>																0000
		15:0																	0000

**Legend:** x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**Note 1:** All registers in this table have corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See **Section 11.2 “CLR, SET and INV Registers”** for more information.

**TABLE 9-2: DMA CRC REGISTER MAP**

Virtual Address (BF88_#)	Register Name <sup>(1)</sup>	Bit Range	Bits															All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	
3030	DCRCCON	31:16	—	—	BYTO<1:0>		WBO	—	—	BITO	—	—	—	—	—	—	—	0000
		15:0	—	—	—	PLEN<4:0>					CRCEN	CRCAPP	CRCTYP	—	—	CRCCH<2:0>		0000
3040	DCRCDATA	31:16	DCRCDATA<31:0>															0000
		15:0																0000
3050	DCRCXOR	31:16	DCRCXOR<31:0>															0000
		15:0																0000

**Legend:** x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**Note 1:** All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See **Section 11.2 “CLR, SET and INV Registers”** for more information.

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## REGISTER 10-11: U1CON: USB CONTROL REGISTER (CONTINUED)

- bit 1     **PPBRST:** Ping-Pong Buffers Reset bit  
          1 = Reset all Even/Odd buffer pointers to the EVEN Buffer Descriptor banks  
          0 = Even/Odd buffer pointers are not Reset
- bit 0     **USBEN:** USB Module Enable bit<sup>(4)</sup>  
          1 = USB module and supporting circuitry is enabled  
          0 = USB module and supporting circuitry is disabled
- SOFEN:** SOF Enable bit<sup>(5)</sup>  
          1 = SOF token is sent every 1 ms  
          0 = SOF token is disabled

- Note 1:** Software is required to check this bit before issuing another token command to the U1TOK register (see Register 10-15).
- 2:** All host control logic is reset any time that the value of this bit is toggled.
- 3:** Software must set RESUME for 10 ms if the part is a function, or for 25 ms if the part is a host, and then clear it to enable remote wake-up. In Host mode, the USB module will append a Low-Speed EOP to the RESUME signaling when this bit is cleared.
- 4:** Device mode.
- 5:** Host mode.

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## 11.0 I/O PORTS

**Note:** This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 12. “I/O Ports”** (DS60001120), which is available from the *Documentation > Reference Manual* section of the Microchip PIC32 web site ([www.microchip.com/pic32](http://www.microchip.com/pic32)).

General purpose I/O pins are the simplest of peripherals. They allow the PIC® MCU to monitor and control other devices. To add flexibility and functionality, some pins are multiplexed with alternate functions.

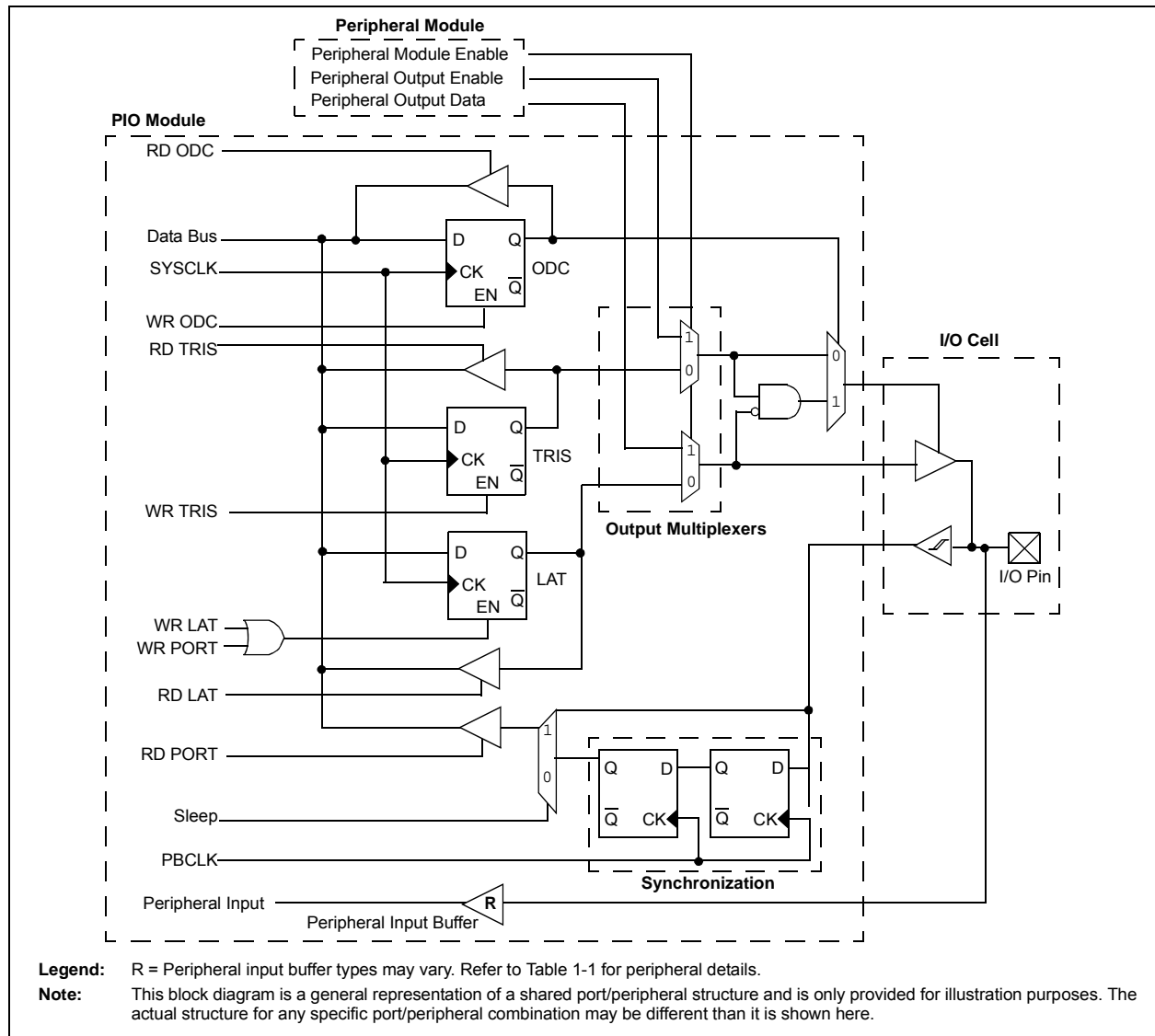
These functions depend on which peripheral features are on the device. In general, when a peripheral is functioning, that pin may not be used as a general purpose I/O pin.

Key features of this module include:

- Individual output pin open-drain enable/disable
- Individual input pin weak pull-up and pull-down
- Monitor selective inputs and generate interrupt when change in pin state is detected
- Operation during Sleep and Idle modes
- Fast bit manipulation using CLR, SET, and INV registers

Figure 11-1 illustrates a block diagram of a typical multiplexed I/O port.

**FIGURE 11-1: BLOCK DIAGRAM OF A TYPICAL MULTIPLEXED PORT STRUCTURE**



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## REGISTER 15-1: ICxCON: INPUT CAPTURE 'x' CONTROL REGISTER (CONTINUED)

bit 2-0      **ICM<2:0>**: Input Capture Mode Select bits

- 111 = Interrupt-Only mode (only supported while in Sleep mode or Idle mode)
- 110 = Simple Capture Event mode – every edge, specified edge first and every edge thereafter
- 101 = Prescaled Capture Event mode – every sixteenth rising edge
- 100 = Prescaled Capture Event mode – every fourth rising edge
- 011 = Simple Capture Event mode – every rising edge
- 010 = Simple Capture Event mode – every falling edge
- 001 = Edge Detect mode – every edge (rising and falling)
- 000 = Input Capture module is disabled

**Note 1:** When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

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## REGISTER 17-3: SPIxSTAT: SPI STATUS REGISTER

- bit 3      **SPITBE:** SPI Transmit Buffer Empty Status bit  
1 = Transmit buffer, SPIxTXB is empty  
0 = Transmit buffer, SPIxTXB is not empty  
Automatically set in hardware when SPI transfers data from SPIxTXB to SPIxSR.  
Automatically cleared in hardware when SPIxBUF is written to, loading SPIxTXB.
- bit 2      **Unimplemented:** Read as '0'
- bit 1      **SPITBF:** SPI Transmit Buffer Full Status bit  
1 = Transmit not yet started, SPITXB is full  
0 = Transmit buffer is not full  
Standard Buffer Mode:  
Automatically set in hardware when the core writes to the SPIBUF location, loading SPITXB.  
Automatically cleared in hardware when the SPI module transfers data from SPITXB to SPISR.  
Enhanced Buffer Mode:  
Set when CWPTR + 1 = SRPTR; cleared otherwise
- bit 0      **SPIRBF:** SPI Receive Buffer Full Status bit  
1 = Receive buffer, SPIxRXB is full  
0 = Receive buffer, SPIxRXB is not full  
Standard Buffer Mode:  
Automatically set in hardware when the SPI module transfers data from SPIxSR to SPIxRXB.  
Automatically cleared in hardware when SPIxBUF is read from, reading SPIxRXB.  
Enhanced Buffer Mode:  
Set when SWPTR + 1 = CRPTR; cleared otherwise



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## REGISTER 20-2: PMMODE: PARALLEL PORT MODE REGISTER (CONTINUED)

bit 1-0    **WAITE<1:0>**: Data Hold After Read/Write Strobe Wait States bits<sup>(1)</sup>

11 = Wait of 4 TPB  
10 = Wait of 3 TPB  
01 = Wait of 2 TPB  
00 = Wait of 1 TPB (default)

For Read operations:

11 = Wait of 3 TPB  
10 = Wait of 2 TPB  
01 = Wait of 1 TPB  
00 = Wait of 0 TPB (default)

- Note 1:** Whenever WAITM<3:0> = 0000, WAITB and WAITE bits are ignored and forced to 1 TPBCLK cycle for a write operation; WAITB = 1 TPBCLK cycle, WAITE = 0 TPBCLK cycles for a read operation.
- 2:** Address bit A14 is not subject to auto-increment/decrement if configured as Chip Select CS1.

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## REGISTER 27-6: DEVID: DEVICE AND REVISION ID REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R	R	R	R	R	R	R	R
	VER<3:0> <sup>(1)</sup>				DEVID<27:24> <sup>(1)</sup>			
23:16	R	R	R	R	R	R	R	R
	DEVID<23:16> <sup>(1)</sup>							
15:8	R	R	R	R	R	R	R	R
	DEVID<15:8> <sup>(1)</sup>							
7:0	R	R	R	R	R	R	R	R
	DEVID<7:0> <sup>(1)</sup>							

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 31-28 **VER<3:0>**: Revision Identifier bits<sup>(1)</sup>

bit 27-0 **DEVID<27:0>**: Device ID bits<sup>(1)</sup>

**Note 1:** See the "PIC32 Flash Programming Specification" (DS60001145) for a list of Revision and Device ID values.

# PIC32MX1XX/2XX 28/36/44-PIN FAMILY

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NOTES:

# PIC32MX1XX/2XX 28/36/44-PIN FAMILY

## 30.0 ELECTRICAL CHARACTERISTICS

This section provides an overview of the PIC32MX1XX/2XX 28/36/44-pin Family electrical characteristics for devices that operate at 40 MHz. Refer to **Section 31.0 “50 MHz Electrical Characteristics”** for additional specifications for operations at higher frequency. Additional information will be provided in future revisions of this document as it becomes available.

Absolute maximum ratings for the PIC32MX1XX/2XX 28/36/44-pin Family devices are listed below. Exposure to these maximum rating conditions for extended periods may affect device reliability. Functional operation of the device at these or any other conditions, above the parameters indicated in the operation listings of this specification, is not implied.

### Absolute Maximum Ratings

(See Note 1)

Ambient temperature under bias .....	-40°C to +105°C
Storage temperature .....	-65°C to +150°C
Voltage on VDD with respect to VSS .....	-0.3V to +4.0V
Voltage on any pin that is not 5V tolerant, with respect to VSS ( <b>Note 3</b> ) .....	-0.3V to (VDD + 0.3V)
Voltage on any 5V tolerant pin with respect to VSS when VDD ≥ 2.3V ( <b>Note 3</b> ) .....	-0.3V to +5.5V
Voltage on any 5V tolerant pin with respect to VSS when VDD < 2.3V ( <b>Note 3</b> ) .....	-0.3V to +3.6V
Voltage on D+ or D- pin with respect to VUSB3V3 .....	-0.3V to (VUSB3V3 + 0.3V)
Voltage on VBUS with respect to VSS .....	-0.3V to +5.5V
Maximum current out of VSS pin(s) .....	300 mA
Maximum current into VDD pin(s) ( <b>Note 2</b> ) .....	300 mA
Maximum output current sunk by any I/O pin .....	15 mA
Maximum output current sourced by any I/O pin .....	15 mA
Maximum current sunk by all ports .....	200 mA
Maximum current sourced by all ports ( <b>Note 2</b> ) .....	200 mA

**Note 1:** Stresses above those listed under “**Absolute Maximum Ratings**” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions, above those indicated in the operation listings of this specification, is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

**2:** Maximum allowable current is a function of device maximum power dissipation (see Table 30-2).

**3:** See the “**Pin Diagrams**” section for the 5V tolerant pins.

# PIC32MX1XX/2XX 28/36/44-PIN FAMILY

**TABLE 30-8: DC CHARACTERISTICS: I/O PIN INPUT SPECIFICATIONS**

DC CHARACTERISTICS			Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \leq T_A \leq +105^{\circ}\text{C}$ for V-temp				
Param. No.	Symbol	Characteristics	Min.	Typical <sup>(1)</sup>	Max.	Units	Conditions
DI10	V <sub>IL</sub>	<b>Input Low Voltage</b> I/O Pins with PMP	V <sub>SS</sub>	—	0.15 V <sub>DD</sub>	V	SMBus disabled (Note 4)
DI18		I/O Pins	V <sub>SS</sub>	—	0.2 V <sub>DD</sub>	V	
DI19		SDAx, SCLx	V <sub>SS</sub>	—	0.3 V <sub>DD</sub>	V	
DI19		SDAx, SCLx	V <sub>SS</sub>	—	0.8	V	SMBus enabled (Note 4)
DI20	V <sub>IH</sub>	<b>Input High Voltage</b> I/O Pins not 5V-tolerant <sup>(5)</sup>	0.65 V <sub>DD</sub>	—	V <sub>DD</sub>	V	(Note 4,6)
		I/O Pins 5V-tolerant with PMP <sup>(5)</sup>	0.25 V <sub>DD</sub> + 0.8V	—	5.5	V	(Note 4,6)
DI28		I/O Pins 5V-tolerant <sup>(5)</sup> SDAx, SCLx	0.65 V <sub>DD</sub> 0.65 V <sub>DD</sub>	— —	5.5 5.5	V V	SMBus disabled (Note 4,6)
DI29		SDAx, SCLx	2.1	—	5.5	V	SMBus enabled, 2.3V ≤ V <sub>PIN</sub> ≤ 5.5 (Note 4,6)
DI30	ICNPU	<b>Change Notification Pull-up Current</b>	—	—	-50	μA	V <sub>DD</sub> = 3.3V, V <sub>PIN</sub> = V <sub>SS</sub> (Note 3,6)
DI31	ICNPD	<b>Change Notification Pull-down Current<sup>(4)</sup></b>	—	—	-50	μA	V <sub>DD</sub> = 3.3V, V <sub>PIN</sub> = V <sub>DD</sub>
DI50	I <sub>IL</sub>	<b>Input Leakage Current (Note 3)</b> I/O Ports	—	—	±1	μA	V <sub>SS</sub> ≤ V <sub>PIN</sub> ≤ V <sub>DD</sub> , Pin at high-impedance
DI51		Analog Input Pins	—	—	±1	μA	V <sub>SS</sub> ≤ V <sub>PIN</sub> ≤ V <sub>DD</sub> , Pin at high-impedance
DI55		$\overline{\text{MCLR}}$ <sup>(2)</sup>	—	—	±1	μA	V <sub>SS</sub> ≤ V <sub>PIN</sub> ≤ V <sub>DD</sub>
DI56		OSC1	—	—	±1	μA	V <sub>SS</sub> ≤ V <sub>PIN</sub> ≤ V <sub>DD</sub> , XT and HS modes

**Note 1:** Data in “Typical” column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

- 2:** The leakage current on the  $\overline{\text{MCLR}}$  pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
- 3:** Negative current is defined as current sourced by the pin.
- 4:** This parameter is characterized, but not tested in manufacturing.
- 5:** See the “Pin Diagrams” section for the 5V-tolerant pins.
- 6:** The V<sub>IH</sub> specifications are only in relation to externally applied inputs, and not with respect to the user-selectable internal pull-ups. External open drain input signals utilizing the internal pull-ups of the PIC32 device are guaranteed to be recognized only as a logic “high” internally to the PIC32 device, provided that the external load does not exceed the minimum value of ICNPU. For External “input” logic inputs that require a pull-up source, to guarantee the minimum V<sub>IH</sub> of those components, it is recommended to use an external pull-up resistor rather than the internal pull-ups of the PIC32 device.

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**TABLE 30-18: PLL CLOCK TIMING SPECIFICATIONS**

AC CHARACTERISTICS		Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +105°C for V-temp					
Param. No.	Symbol	Characteristics <sup>(1)</sup>	Min.	Typical	Max.	Units	Conditions
OS50	FPLLI	PLL Voltage Controlled Oscillator (VCO) Input Frequency Range	3.92	—	5	MHz	ECPLL, HSPLL, XTPLL, FRCPLL modes
OS51	FSYS	On-Chip VCO System Frequency	60	—	120	MHz	—
OS52	TLOCK	PLL Start-up Time (Lock Time)	—	—	2	ms	—
OS53	DCLK	CLKO Stability <sup>(2)</sup> (Period Jitter or Cumulative)	-0.25	—	+0.25	%	Measured over 100 ms period

**Note 1:** These parameters are characterized, but not tested in manufacturing.

**Note 2:** This jitter specification is based on clock-cycle by clock-cycle measurements. To get the effective jitter for individual time-bases on communication clocks, use the following formula:

$$EffectiveJitter = \frac{D_{CLK}}{\sqrt{\frac{SYSCLK}{CommunicationClock}}}$$

For example, if SYSCLK = 40 MHz and SPI bit rate = 20 MHz, the effective jitter is as follows:

$$EffectiveJitter = \frac{D_{CLK}}{\sqrt{\frac{40}{20}}} = \frac{D_{CLK}}{1.41}$$

**TABLE 30-19: INTERNAL FRC ACCURACY**

AC CHARACTERISTICS		Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +105°C for V-temp				
Param. No.	Characteristics	Min.	Typical	Max.	Units	Conditions
Internal FRC Accuracy @ 8.00 MHz <sup>(1)</sup>						
F20b	FRC	-0.9	—	+0.9	%	—

**Note 1:** Frequency calibrated at 25°C and 3.3V. The TUN bits can be used to compensate for temperature drift.

**TABLE 30-20: INTERNAL LPRC ACCURACY**

AC CHARACTERISTICS		Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +105°C for V-temp				
Param. No.	Characteristics	Min.	Typical	Max.	Units	Conditions
LPRC @ 31.25 kHz <sup>(1)</sup>						
F21	LPRC	-15	—	+15	%	—

**Note 1:** Change of LPRC frequency as VDD changes.

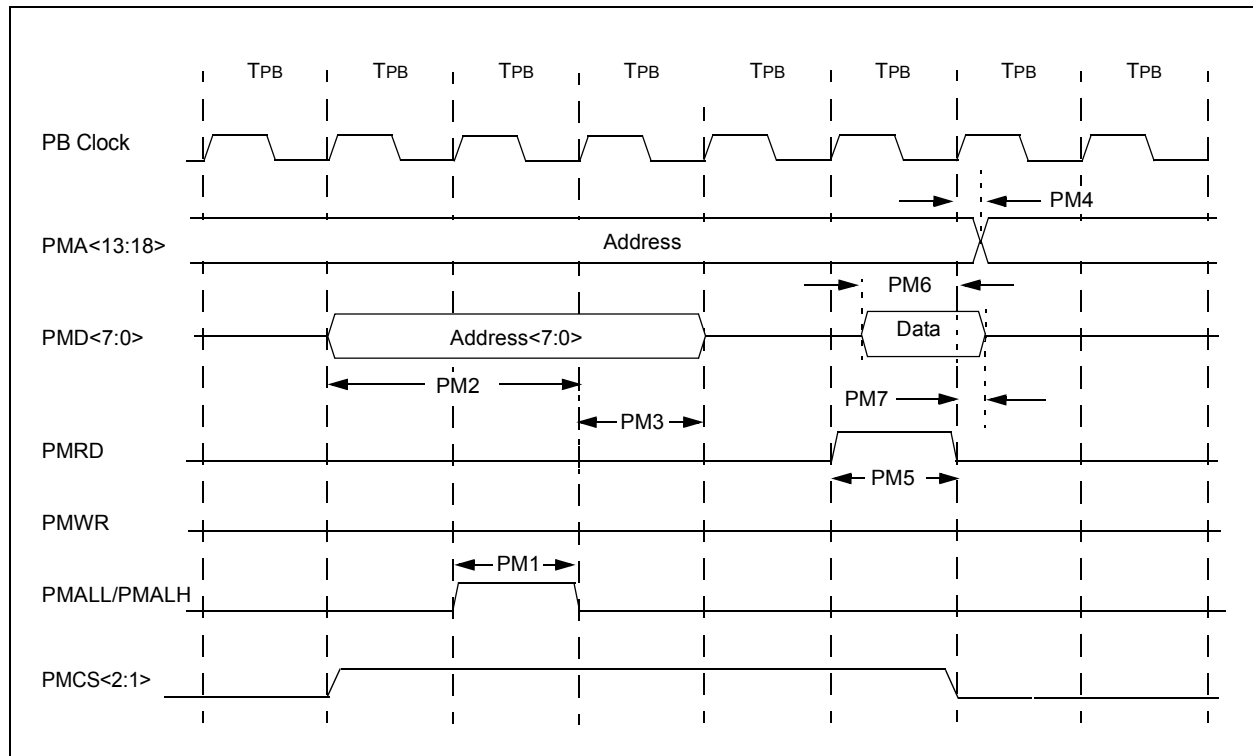
# PIC32MX1XX/2XX 28/36/44-PIN FAMILY

**TABLE 30-37: PARALLEL SLAVE PORT REQUIREMENTS**

AC CHARACTERISTICS			Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \leq T_A \leq +105^{\circ}\text{C}$ for V-temp				
Para m.No.	Symbol	Characteristics <sup>(1)</sup>	Min.	Typ.	Max.	Units	Conditions
PS1	TdtV2wr H	Data In Valid before $\overline{\text{WR}}$ or $\overline{\text{CS}}$ Inactive (setup time)	20	—	—	ns	—
PS2	TwrH2dt I	$\overline{\text{WR}}$ or $\overline{\text{CS}}$ Inactive to Data-In Invalid (hold time)	40	—	—	ns	—
PS3	TrdL2dt V	$\overline{\text{RD}}$ and $\overline{\text{CS}}$ Active to Data-Out Valid	—	—	60	ns	—
PS4	TrdH2dtI	$\overline{\text{RD}}$ Active or $\overline{\text{CS}}$ Inactive to Data-Out Invalid	0	—	10	ns	—
PS5	Tcs	$\overline{\text{CS}}$ Active Time	TPB + 40	—	—	ns	—
PS6	TWR	$\overline{\text{WR}}$ Active Time	TPB + 25	—	—	ns	—
PS7	TRD	$\overline{\text{RD}}$ Active Time	TPB + 25	—	—	ns	—

**Note 1:** These parameters are characterized, but not tested in manufacturing.

**FIGURE 30-21: PARALLEL MASTER PORT READ TIMING DIAGRAM**





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NOTES:

FIGURE 32-6: TYPICAL FRC FREQUENCY @ VDD = 3.3V

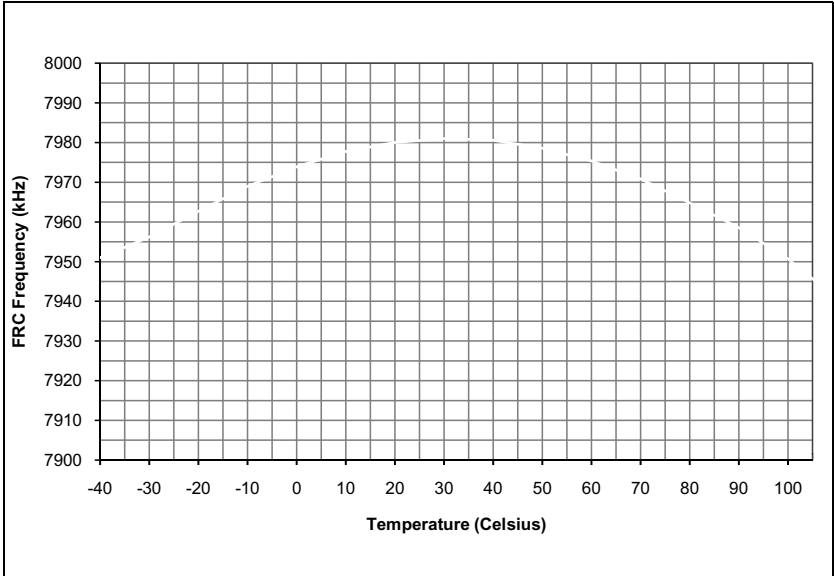


FIGURE 32-7: TYPICAL LPRC FREQUENCY @ VDD = 3.3V

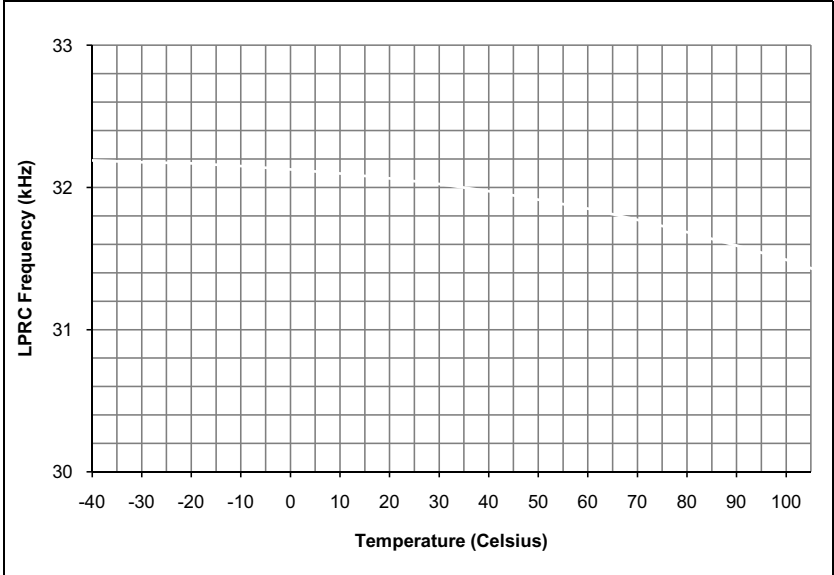
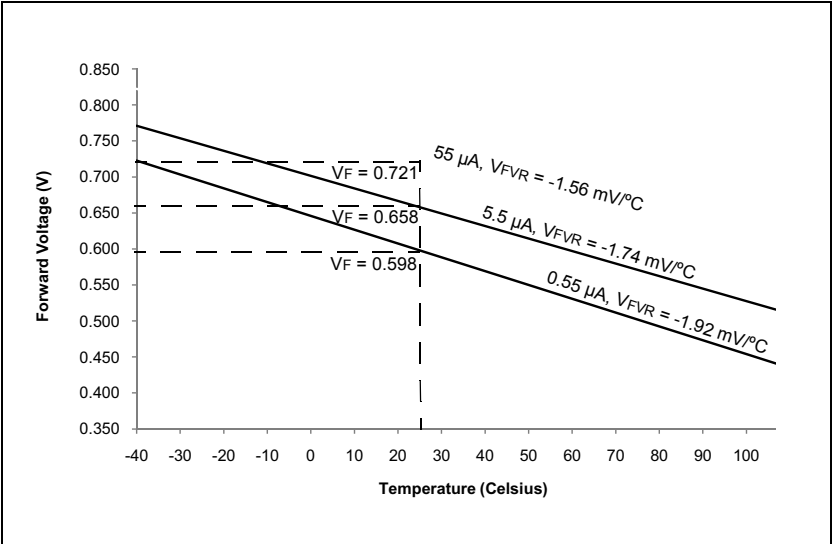


FIGURE 32-8: TYPICAL CTMU TEMPERATURE DIODE FORWARD VOLTAGE

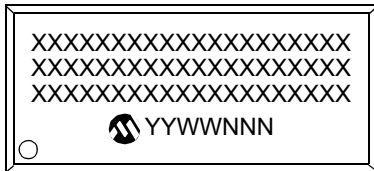


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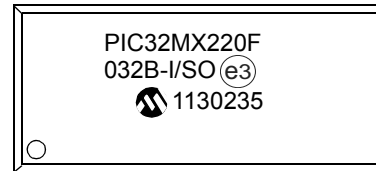
## 33.0 PACKAGING INFORMATION

### 33.1 Package Marking Information

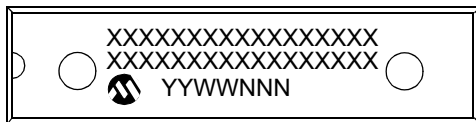
28-Lead SOIC



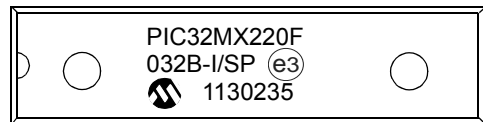
Example



28-Lead SPDIP



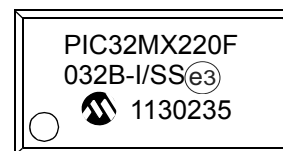
Example



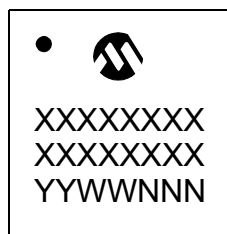
28-Lead SSOP



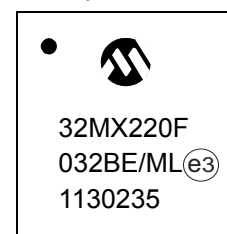
Example



28-Lead QFN



Example



<b>Legend:</b>	XX...X	Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.
<b>Note:</b>	If the full Microchip part number cannot be marked on one line, it is carried over to the next line, thus limiting the number of available characters for customer-specific information.	



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## Revision E (October 2012)

All singular pin diagram occurrences of CVREF were changed to: CVREFOUT. In addition, minor text and formatting changes were incorporated throughout the document.

All major changes are referenced by their respective section in Table A-4.

**TABLE A-4: MAJOR SECTION UPDATES**

Section	Update Description
<b>“32-bit Microcontrollers (up to 128 KB Flash and 32 KB SRAM) with Audio and Graphics Interfaces, USB, and Advanced Analog”</b>	Updated the following feature sections: <ul style="list-style-type: none"><li>• <b>“Operating Conditions”</b></li><li>• <b>“Communication Interfaces”</b></li></ul>
<b>2.0 “Guidelines for Getting Started with 32-bit MCUs”</b>	Removed Section 2.8 “Configuration of Analog and Digital Pins During ICSP Operations”.
<b>3.0 “CPU”</b>	Removed references to GPR shadow registers in <b>3.1 “Features”</b> and <b>3.2.1 “Execution Unit”</b> .
<b>4.0 “Memory Organization”</b>	Updated the BRG bit range in the SPI1 and SPI2 Register Map (see Table 4-8). Added the PWP<6> bit to the Device Configuration Word Summary (see Table 4-17).
<b>5.0 “Flash Program Memory”</b>	Added a note with Flash page size and row size information.
<b>7.0 “Interrupt Controller”</b>	Updated the TPC<2:0> bit definitions (see Register 7-1). Updated the IPTMR<31:0> bit definition (see Register 7-3).
<b>8.0 “Oscillator Configuration”</b>	Updated the PIC32MX1XX/2XX Family Clock Diagram (see Figure 8-1). Updated the RODIV<14:0> bit definitions (see Register 8-3).
<b>10.0 “USB On-The-Go (OTG)”</b>	Updated the Notes in the USB Interface Diagram (see Figure 10-1).
<b>18.0 “Universal Asynchronous Receiver Transmitter (UART)”</b>	Updated the baud rate range in the list of primary features.
<b>26.0 “Special Features”</b>	Added the PWP<6> bit to the Device Configuration Word 0 (see Register 26-1).
<b>29.0 “Electrical Characteristics”</b>	Added Note 1 to Operating MIPS vs. Voltage (see Table 29-1). Added Note 2 to DC Temperature and Voltage Specifications (see Table 29-4). Updated the Conditions for parameter DC25 in DC Characteristics: Operating Current (IDD) (see Table 29-5). Added Note 2 to Electrical Characteristics: BOR (see Table 29-10). Added Note 4 to Comparator Specifications (see Table 29-12). Added Note 5 to ADC Module Specifications (see Table 29-32). Updated the 10-bit Conversion Rate Parameters and added Note 3 (see Table 29-33). Added Note 4 to the Analog-to-Digital Conversion Timing Requirements (see Table 29-34). Added Note 3 to CTMU Current Source Specifications (see Table 29-39).
<b>30.0 “50 MHz Electrical Characteristics”</b>	New chapter with electrical characteristics for 50 MHz devices.
<b>31.0 “Packaging Information”</b>	The 36-pin and 44-pin VTLA packages have been updated.